SPE	FI	$C \Lambda$	TI	\bigcirc	N	C
SIL	 ГΙ	UН		u	v	J

CUSTOMER .

SAMPLE CODE . SH320240T028-ZHC01

MASS PRODUCTION CODE PH320240T028-ZHC01

PCAP FIRMWARE VERSION . CW035012_V2_20171117.bin

SAMPLE VERSION . 01

SPECIFICATIONS EDITION . 006

DRAWING NO. (Ver.) . LMD-PH320240T028-ZHC01 (Ver.002)

PACKAGING NO. (Ver.) . PKG- PH320240T028-ZHC01 (Ver.001)

Customer Approved

Date:

Approved	Checked	Designer
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Preliminary specification for design input

Specification for sample approval

2023.03.06 TW RD APR

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
06/14/2019	01	001	New Drawing		Howard
			New Sample	-	
10/31/2019	01	002	Add Ts Note1 & Ta Note 2	5	Howard
			Modify Component height and Add Print Line	Appendix	
04/20/2020	01	003	According to customer request modify Contents	-	Howard
06/02/2020	01	004	According to customer request modify Contents	-	Howard
			DCLK polarity from falling modify to rising	13	
09/15/2022	01	005	Modify Timing Characteristics	15~18	Howard
00/10/2022	0 1		Modify Power ON/OFF Sequence	20	riowara
			Modify Inspection Specification	24~30	
03/02/2022	01	006	Modify ID Pins Definition	13	Howard



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Appendix: 1. LCM Drawing

2. Packing Specification

Note: For detailed information please refer to IC data sheet:

Primacy(TFT LCD): Sitronix: ST7272A



1. SPECIFICATIONS

1.1 Features

<u>ltem</u>	Standard Value				
Display Type	320 * 3 (RGB) * 240 Dots				
LCD Type	Full Viewing Angle, Normally Black, Transmissive type				
Screen size(inch)	3.5 inch				
Surface treatment	Anti-Glare				
Color configuration	RGB-Strip				
Backlight Type	White LED B/L				
Interface	Parallel RGB (Data), SPI (Configuration)				
Other(controller/driver IC)	ST7272A (Or Compatible IC)				
	THIS PRODUCT CONFORMS THE ROHS OF PTC				
ROHS	Detail information please refer website :				
	http://www.powertip.com.tw/news_detail.php?Key=1&cID=1				

1.2 Mechanical Specifications

<u>Item</u>	Standard Value	<u>Unit</u>
Outline Dimension	76.9(W) * 63.9(L) * 5.05(H)	mm

LCD Panel

<u>Item</u>	<u>Standard Value</u>	<u>Unit</u>
Active Area	70.08(W) * 52.56(L)	mm
Pixel Size	0.219(W) * 0.219(H)	mm

Note: For detailed information please refer to LCM drawing



1.3 Absolute Maximum Ratings

Module

<u>ltem</u>	Symbol	Condition	Min.	Max.	<u>Unit</u>	Remark
Power Supply for TFT Panel	VDD	GND=0	-0.3	4.5	V	
Power Supply for Backlight Unit	VCC	GND=0	-0.3	+20.0	V	->
Operating Temperature	Top (Ts)	Note 1	-20	70	°C	
Storage Temperature	T _{ST} (Ta)	Note 2	-30	80	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any time. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

Note 1: Ts is the temperature of panel's surface

Note 2: Ta is the ambient temperature of samples

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = $25^{\circ}C$

<u>ltem</u>	Symbol	Condition	Min.	<u>Typ.</u>	Max.	<u>Unit</u>
Power Supply for TFT Panel	VDD	GND=0V	3.0	3.3	3.6	V
Power Supply for Backlight Unit	VCC	GND=0V	5	12	15	V
Input Voltage for	ViH	GND=0V	0.7VDD	1	VDD	
TFT Panel	VIL	GND=0V	0	-	0.3VDD	V
Supply Current for TFT Panel	IDD	IDD@VDD=3.3V	-	25	40	
Supply Current for Backlight Unit	ICC	ICC@VCC=5V	ı	170	260	mA
Supply Current for Backlight Unit	ICC	ICC@VCC=12V	-	70	105	
Input Voltage for	VPH	GND=0V	1.2	-	-	V
PWM Signal	VPL	GND=0V	-	-	0.4	V
Dimming Clock Rate	fP	GND=0V	5	-	100	KHz



1.5 Optical Characteristics

TFT LCD Module

VDD = 3.3 V, Ta=25°C

<u>ltem</u>	<u>Symbol</u>		Condition	Min.	Typ.	Max.	<u>unit</u>	
Response time	Tr	+Tf	Ta = 25°C θX, θY = 0°	-	30	40	ms	Note 2
	Тор	θΥ+		_	80	-		
Viowing angle	Bottom	θΥ-	CR ≥ 10		80	-	Dog	Note 4
Viewing angle	Left	θX-	CR 2 10	-	80	-	Deg.	Note 4
	Right	θΧ+		-	80	-		
Contrast ratio	1	CR		650	800	>		Note 3
	White	Х		0.23	0.28	0.33		
	vviille	Υ		0.27	0.32	0.37	_	
	Red	X	Ta = 25°C θX , θY = 0°	0.57	0.62	0.67		
Color of CIE Coordinate		Y		0.31	0.36	0.41		Note1
(With B/L & TP)	Green	X		0.29	0.34	0.39		Note
		Υ		0.55	0.60	0.65		
	Blue	Х		0.09	0.14	0.19		
	Diue	Y		0.04	0.09	0.14		
Average Brightness			VCC=12.0V					
Pattern=white display		F	PWM="High"	650	800	-	cd/m ²	Note1
(With B/L & TP) *1			(Duty=100%)					
Uniformity			VCC=12.0V					
Uniformity (With B/L & TP) *2		ΔB	PWM="High"	70	-	-	%	Note1
(Williams & Tr.) Z			(Duty=100%)					



Note 1:

*1: △B=B(min) / B(max) * 100%

*2: Measurement Condition for Optical Characteristics:

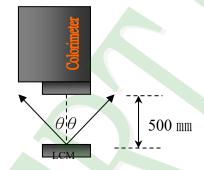
a: Environment: 25°C±5°C / 60±20%R.H, no wind, dark room below 10 Lux at typical lamp current and typical operating frequency

b: Measurement Distance: 500 ± 50 mm, $(\theta = 0^{\circ})$

c: Equipment: TOPCON BM-7 fast, (field 1°), after 10 minutes operation

d: The uncertainty of the C.I.E coordinate measurement ±0.01, Average Brightness ± 4%





Colorimeter=BM-7 fast

To be measured at the center area of panel with a viewing cone of 1° by Topcon luminance meter BM-7, after 10 minutes operation (module)

Note 2: Definition of response time:

The output signals of photo detector are measured when the input signals are changed from "black" to "white" (falling time) and from "white" to "black" (rising time), respectively. The response time is defined as the time interval between the 10% and 90% of Amplitudes.

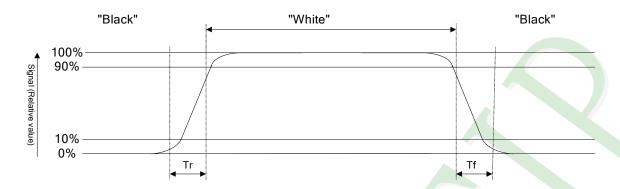
Refer to figure as below:

Normally White





Normally Black



Note 3: Definition of contrast ratio:

Contrast ratio is calculated with the following formula

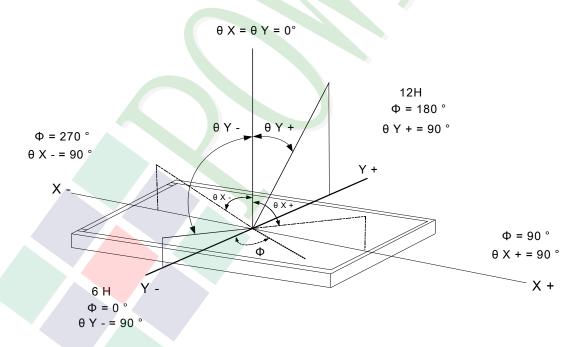
Photo detector output when LCD is at "White" state

Contrast ratio (CR) =

Photo detector output when LCD is at "Black" state

Note 4: Definition of viewing angle:

Refer to figure as below:





1.6 Backlight Characteristics

Maximum Ratings

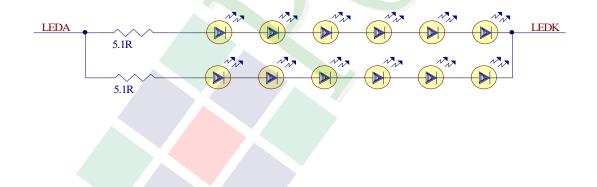
<u>ltem</u>	<u>Symbol</u>	Min.	Max.	<u>Unit</u>	<u>Remark</u>
LED Forward Current	lF	30		mA	One I ED
LED Reverse Voltage	VR	5	.0	V	One LED

Electrical / Optical Characteristics

<u>Item</u>	<u>Symbol</u>	Min.	<u>Тур.</u>	Max.	<u>Unit</u>	<u>Remark</u>
LED Voltage	VL	18.0	19.0) -	V	Note1
LED Current	IL	-	40	(mA	-
LED life time	-	50,000	-	-	Hr	Note2

Note 1: The LED Supply Voltage is defined by the number of LED at Ta=25℃ and I∟=40 mA

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at Ta=25℃ and I_L =40 mA. The LED life time could be decreased if operating I_L is larger than 40 mA





1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	3.5"
Touch type	True Multi-Touch Capacitive Touch Panel
Input Method	True Multi-touch with up to 5 Points of Absolution X and Y Coordinates
Output Interface	I ² C
IC	HY4635

I²C Address

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
0	1	1	1	0	0	0	R/W

Bit 0: 0 for Write / 1 for Read

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	TPVDD	-	-0.3	3.6	V
Operating Temperature	Тор	Non condensing	-20	70	°C
Storage Temperature	Tst	Non condensing	-30	80	°C

DC Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Power Supply Voltage	TPVDD	1	-	3.3	-	V

Optical Characteristics

Item	Standard Value	Unit
Total light transmittance	85% or more	-
Hardness	≥6H	-

PCAP Firmware Information

File: CW035012_V2_20171117.bin

SHA-256: F73E1631AD350878F3A179D8C8B3BF0C5C50DB10CBC82BCC84CE396FF45E929E

Remark: None



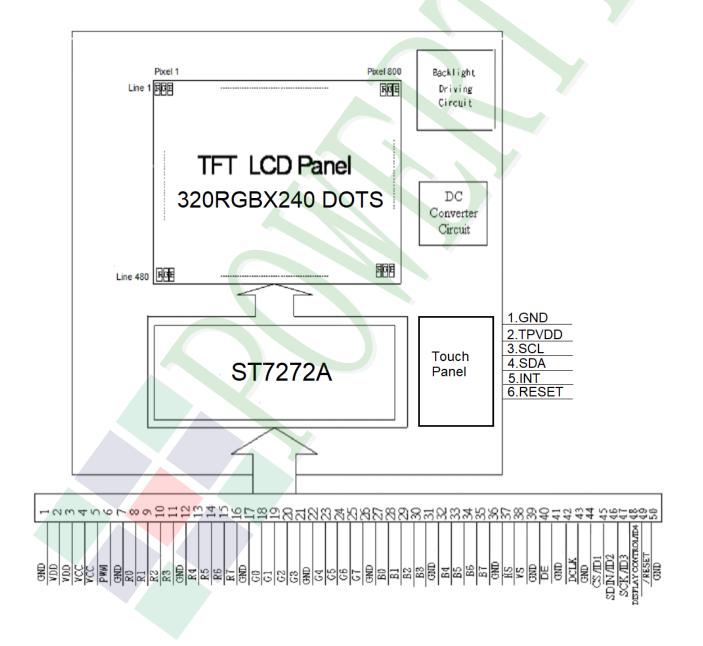
2. Module Structure

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram





2.2 Interface Pin Description

TFT LCM Interface

Pin#	<u>Name</u>	<u>Description</u>
1	GND	Power ground.
2	VDD	Power for Digital Circuit.
3	VDD	Power for Digital Circuit.
4	VCC	Power For LED backlight.
5	VCC	Power For LED backlight.
6	PWM	Shutdown & Dimming control input for backlight. Do not allow this pin to float. "Hi" =100%, "Low" = 0%.
7	GND	Power ground.
8	R0	Red Data.
9	R1	Red Data.
10	R2	Red Data.
11	R3	Red Data.
12	GND	Power ground.
13	R4	Red Data.
14	R5	Red Data.
15	R6	Red Data.
16	R7	Red Data.
17	GND	Power ground.
18	G0	Green Data.
19	G1	Green Data.
20	G2	Green Data.
21	G3	Green Data.
22	GND	Power ground.
23	G4	Green Data.
24	G5	Green Data.
25	G6	Green Data.
26	G7	Green Data.
27	GND	Power ground.
28	В0	Blue Data.
29	B1	Blue Data.



Pin#	<u>Name</u>	DESCRIPTION
30	B2	Blue Data.
31	В3	Blue Data.
32	GND	Power ground.
33	B4	Blue Data.
34	B5	Blue Data.
35	B6	Blue Data.
36	В7	Blue Data.
37	GND	Power ground.
38	HS	Line synchronization signal. Horizontal Sync Input.
39	VS	Frame synchronization signal. Vertical Sync Input.
40	GND	Power ground.
41	DE	Data Enable.
42	GND	Power ground.
43	DCLK	Sample clock. Data will be latched at the rising edge of DCLK.
44	GND	Power ground.
45	CS/ ID1	Serial communication chip selection/ID[4:1]These pins select LCM type. See NOTE1
46	SDIN/ ID2	Serial communication data/ ID[4:1]These pins select LCM type. See NOTE1
47	SCK/ ID3	Serial communication clock/ ID[4:1]These pins select LCM type. See NOTE1
48	DISPLAY CONTROL / ID4	Display Enable(Hi Active)./ ID[4:1]These pins select LCM type. See NOTE1
49	/RESET	Global Reset (Low Active).
50	GND	Power ground.

Note1:

ID Pins Definition:

	PIN 45 ID1	<u>PIN 46 ID2</u>	<u>PIN 47 ID3</u>	<u>PIN 48 ID4</u>
3.5" Module	Х	0	0	X
4.3" Module	X	1	0	X
5.0" Module	X	0	1	Х
7.0" Module	X	1	1	Х

^{1.} Resistor = 10k ohm

^{2. &}quot;X" = No use



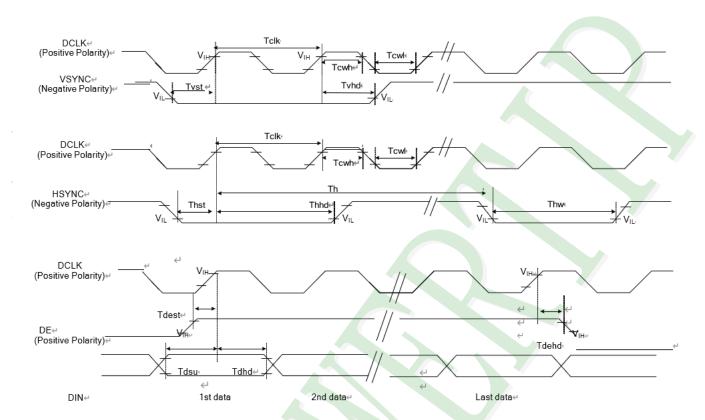
2.3 Timing Characteristics

2.3.1 RGB Mode Selection Table

RGB Mode Selection Table	<u>DCLK</u>	<u>HSYNC</u>	<u>VSYNC</u>	<u>DE</u>
SYNC - DE Mode	Input	Input	Input	Input
SYNC Mode	Input	Input	Input	GND
DE Mode	Input	GND	GND	Input



2.3.2 System Bus Timing for RGB Interface

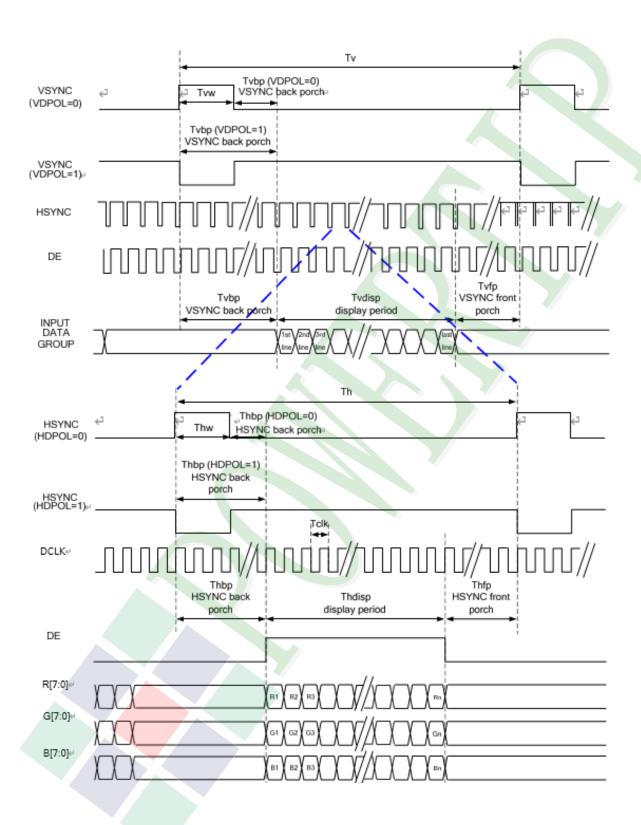


VDD= 3.3V, Ta=25°C

<u>ltem</u>	Symbol	Min	<u>Typ.</u>	Max	<u>Unit</u>	<u>Conditions</u>
CLK Pulse Duty	Tclk	40	50	60	%	
HSYNC Width	Thw	2	-	-	DCLK	
HSYNC Period	Th	55	60	65	us	
VSYNC Setup Time	Tvst	12	-	-	ns	
VSYNC Hold Time	Tvhd	12	-	-	ns	
HSYNC Setup Time	Thst	12	-	-	ns	
HSYNC Hold Time	Thhd	12	-	-	ns	
Data Setup Time	Tdsu	12	-	-	ns	
Data Hold Time	Tdhd	12	-	-	ns	
DE Setup Time	Tdest	12	-	-	ns	
DE Hold Time	Tdehd	12	-	-	ns	

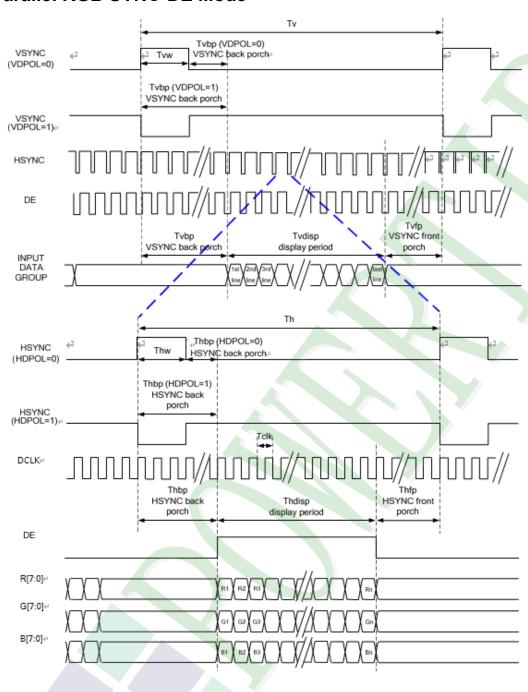


2.3.3 Parallel RGB SYNC Mode



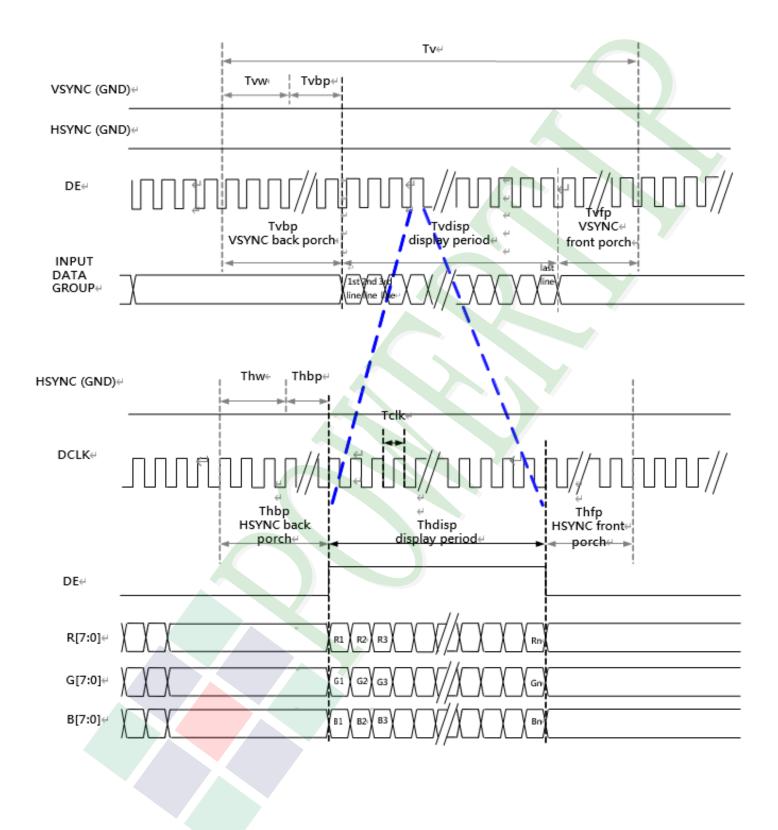


2.3.4 Parallel RGB SYNC-DE Mode





2.3.5 Parallel RGB DE Mode





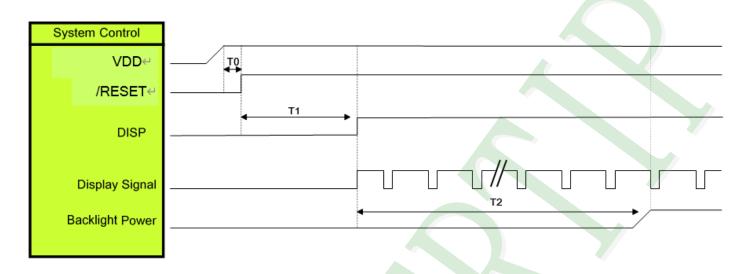
2.3.6 Parallel RGB Input Timing Table

	Parallel 24-bit RGB Input Timing Table								
<u>P</u> :	<u>arameter</u>	<u>Symbol</u>	<u>Min</u>	Тур	<u>Max</u>	<u>Unit</u>	<u>Note</u>		
DCL	K frequency	Fclk	5	6	8	MHz			
DC	CLK Period	Tclk	125	167	200	ns			
	Period Time	Th	325	371	438				
	Display Period	Thdisp		320					
HSYNC	Back Porch	Thbp	3	43	43	DCLK	SYNC mode back porch control by H_BLANKING[7:0] setting Thbp= H_BLANKING[7:0]		
	Front Porch	Thfb	2	8	75				
	Pulse Width	Thw	2	4	43				
	Period Time	Tv	244	260	289				
	Display Period	Tvdisp		240					
VSYNC	Back Porch	Tvbp	2	12	12	HSYNC	SYNC mode back porch control by V_BLANKING[7:0] setting Thbp= V_BLANKING[7:0]		
	Front Porch	Tvfb	2	8	37				
	Pulse Width	Tvw	2	4	12				



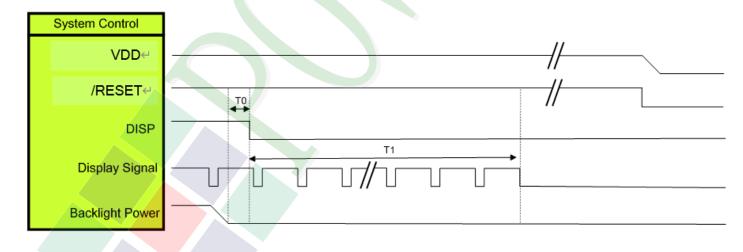
2.3.7 Power ON/OFF Sequence

Power ON Sequence



<u>Symbol</u>	<u>Description</u>	Min. Time	<u>Unit</u>
T0	System power stability to GRB RESET signal	0	ms
T1	GRB RESET= "High" to DISP="High"	10	ms
T2	Display Signal output to Backlight Power on	250	ms

Power OFF Sequence



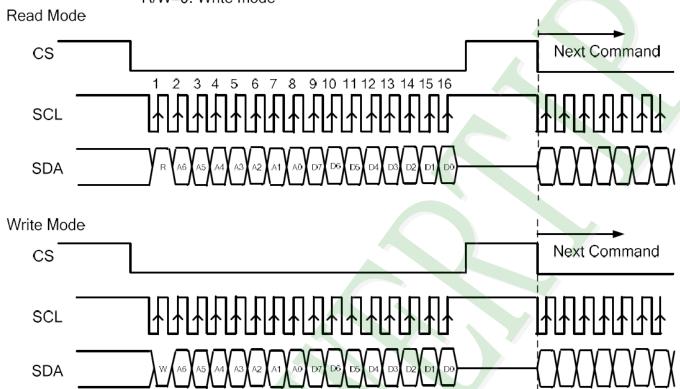
<u>Symbol</u>	<u>Description</u>	Min. Time	<u>Unit</u>
T0	Backlight Power off to DISP="Low"	5	ms
T1	DISP="Low" to IC internal voltage discharge complete	80	ms



2.4 3-wire Serial Interface (SPI)

R/W: Read/Write mode control bit.

R/W=1: Read mode R/W=0: Write mode

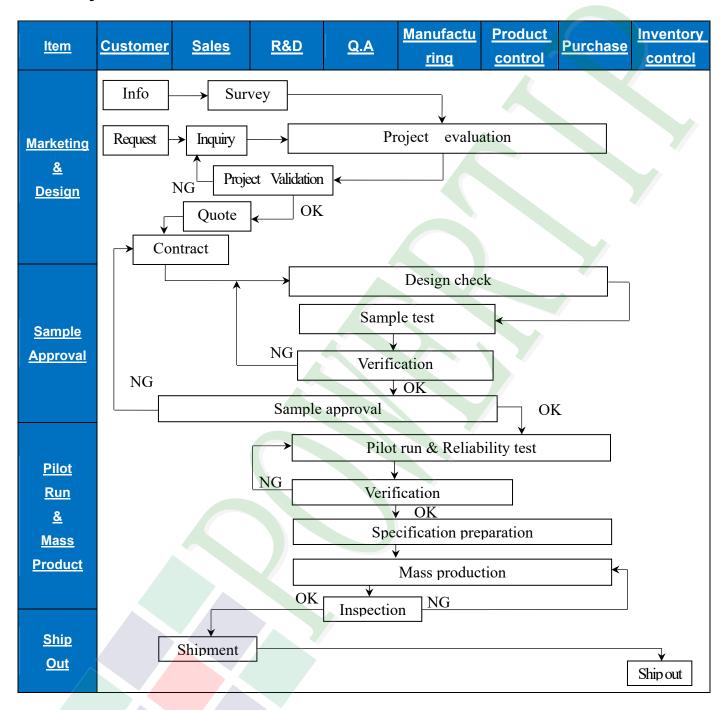


- **a.** Each serial command consists of 16 bits of data which is loaded one bit a time at the rising edge of serial clock SCL.
- **b.** Common loading operation starts from the falling edge of CS and is completed at the next rising edge of CS.
- **c.** The serial control block is operational after power on reset, but commands are established by the VSYNC signal. If command is transferred multiple times for the same register, the last command before the VSYNC signal is valid.
- d. If less than 16 bits of SCL are input while CS is low, the transferred data is ignored.
- **e.** If 16 bits or more of SCL are input while CS is low, the previous 16 bits of transferred data before then rising edge of CS pulse are valid data.
- f. Serial block operates with SCL clock.
- g. Serial data can be accepted in the power save mode.
- h. After power on reset or GRB reset, it is required 100ms delay to begin SPI communication.

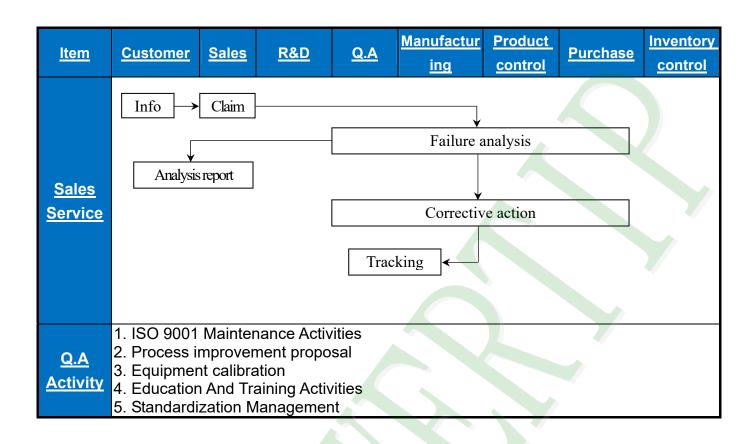


3. Quality Assurance System

3.1 Quality Assurance Flow Chart









3.2 Inspection Specification

◆Scope: The document shall be applied to TFT-LCD Module for 3. 5" -15" (Ver.B01).

◆Inspection Standard: MIL-STD-105E Table Normal Inspection Single Sampling Level II.

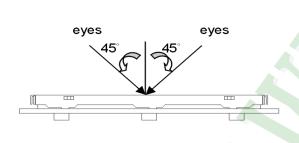
◆Equipment: Gauge, MIL-STD, Powertip Tester, Sample

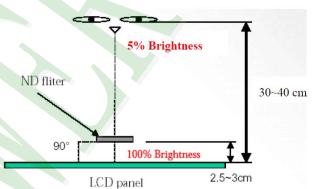
◆Defect Level: Major Defect AQL: 0. 4; Minor Defect AQL: 1. 5

♦OUT Going Defect Level: Sampling

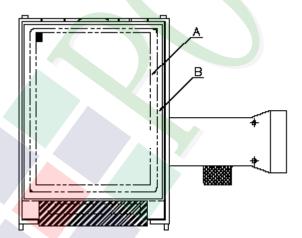
♦Standard of the product appearance test:

- a. Manner of appearance test:
- (1). The test best be under $20W\times2$ fluorescent light(about $300lux \sim 500lux$) and distance of view must be at $30\sim40$ cm.
- (2). The test direction is base on about around 45° of vertical line.





(3). Definition of area.



A area: viewing area

B area: Outside of viewing area

(4). Standard of inspection: (Unit: mm)



◆Specification For TFT-LCD Module 3. 5" ~15":

<u>NO</u>	<u>Item</u>	<u>Criterion</u>			
		1. 1 The part number is inconsistent with work order of production.			
01	Product condition	1. 2 Mixed product types.	Major		
		1. 3 Assembled in inverse direction.	Major		
02	Quantity	2. 1 The quantity is inconsistent with work order of production.	Major		
03	Outline dimension	3. 1 Product dimension and structure must conform to structure diagram.	Major		
		4. 1 Missing line character and icon.	Major		
		4. 2 No function or no display.	J		
0.4		4. 3 Display malfunction.	Major		
04	Electrical Testing	4. 4 LCD viewing angle defect.			
		4. 5 Current consumption exceeds product specifications.			
		4. 6 Mura cannot be seen through 5% ND filter at 50% Gray, should be judged by the viewing angle of 90 degree.	Minor		
		Item Acceptance (Q'ty)			
		Bright Dot ≤ 4			
		Dot Dark Dot ≤ 5			
	D (1.6. (Defect Joint Dot ≤ 3			
	Dot defect	Total ≤ 7	Major		
	(Bright dot,	5. 1 Inspection pattern: full white, full black, Red, Green and			
05	Dark dot)	blue screens.	Minor		
	On -display	5. 2 It is defined as dot defect if defect area $>1/2$ dot.			
		5. 3 The distance between two dot defect ≥5 mm.			
		5. 4 Bright dot that can not be seen through 5% ND filter.			
		5. 5 Tiny bright dot: bright dot area ≤1/2 dot.			
		a.Dots appear bright and unchanged in visible with 5% ND filter is defined defect and is judged in accordance with 6.1			
		b. Dots invisible with 5% ND Filter is Ignored.			



◆Specification For TFT-LCD Module 3. 5″ ~15″:

<u>NO</u>	<u>Item</u>	<u>Criterion</u>				Level				
		6.1 R	Round type	(Non-displ	ay or d	isplay):				
						Aggente	nce (Q'ty)			
			Dimension	<u>n (diameter</u>	<u>:: Ф)</u>	Accepta A area	B ar			
				$\Phi \leq 0$.	25	Ignore				
	Black or white		0.25	$<\Phi \leq 0.5$	50	5	Igno	ro		
	Dot, scratch,			$\Phi > 0$.50	0	Igno			
	contamination			Total		5				
	Round type	6. 2 L	ine type(No	on-display	or disp	lay):				
	Y	me	odule size	Length	W	idth (W)	Acceptan			
06	1		oddie size	<u>(L)</u>		$W \leq 0.03$	A area	B area	Minor	
	$\Phi = (x+y)/2$			L	0.02		Ignore	1		
				≦10.0		$<$ W ≤ 0.05	4			
			<u>3.</u>	<u>5" to less</u> <u>9"</u>	L ≦5.0	0.05	<w 0.10<="" td="" ≤=""><td>2</td><td>Ignore</td><td></td></w>	2	Ignore	
	Line type		<u>9</u>			W >	As round			
	/ W					0.10	type			
					Tota		5			
	L			L ≤10.0	0.05	$W \le 0.05$ $< W \le 0.10$	Ignore 5	_		
		0	22 4 1 722	L = 10.0	0.03	W >	As			
		<u>9</u>	" to 15"			0.10	round	Ignore		
					Tota		type 5	_		
					1000	•				
				imension (diameter: (D)		tance (Q'ty		
				$\Phi \leq 0.25$		<u>A area</u> Ignore	<u>B</u>	area_		
07	Polarizer			$\Phi \stackrel{=}{=} 0.23$ $\Phi \stackrel{\leq}{=} 0.50$		4			Minor	
	Bubble			$\Phi \leq 0.80$		1	Iş	gnore		
				$\Phi > 0.80$		0				
			To	tal		5				



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	Item	Criterion Criterion		
		Symbols: X: The length of crack Z: The thickness of crack T: The thickness of glass X: The width of crack W: terminal length T: The thickness of glass a: LCD side length		
		8. 1 General glass chip: 8. 1. 1 Chip on panel surface and crack between panels:		
08	The crack of glass	SP SP [NG]	Minor	
		Seal width Z		
		$\frac{X}{4}$ $\frac{Y}{4}$ $\frac{Z}{4}$ Z		
		\leq a Crack can't exceed the half of SP width. 1/2 t < Z \leq 2 t		



◆Specification For TFT-LCD Module 3. 5″ ~15″:

NO NO	<u>Item</u>	<u>Criterion</u>			
	X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 1. 2 Corner crack:				
		$\frac{X}{\sqrt{5}}$ Crack can't enter $\frac{Z}{\sqrt{5}}$			
		$\leq 1/5$ a Crack can't enter viewing area $Z \leq 1/2$ t $\leq 1/5$ a Crack can't exceed the half of SP width. $1/2$ t < Z ≤ 2 t			
08	The crack of glass 8.2 Protrusion over terminal:				
	8. 2. 1 Chip on electrode pad: W X X X X X X X X X X X X X X X X X X				
	X				
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$			
		$\begin{array}{ c c c c c } \hline Back & \leq a & \leq W & \leq 1/2 t \\ \hline \end{array}$			



◆Specification For TFT-LCD Module 3. 5″~15″:

NO	<u>Item</u>	<u>Criterion</u>	Level
	Item The crack of glass	Symbols: X: The length of crack Z: The thickness of crack t: The thickness of glass 8. 2. 2 Non-conductive portion: X Y Z Z \$\frac{X}{2}\$ \$\frac{Y}{2}\$ \$\frac{Z}{2}\$	Level
		8. 2. 3 Glass remain:	



◆Specification For TFT-LCD Module 3. 5″ ~15″:

<u>NO</u>	<u>Item</u>	<u>Criterion</u>	Level	
09		9. 1 Backlight can't work normally.	Major	
	Backlight elements 9. 2 Backlight doesn't light or color is wrong.	9. 2 Backlight doesn't light or color is wrong.	Major	
			9. 3 Illumination source flickers when lit.	Major
10		10. 1 Pin type, quantity, dimension must match type in structure diagram.	Major Major Major Major Major	
		10. 2 No short circuits in components on PCB or FPC.	Major	
	General	10. 3 Parts on PCB or FPC must be: no wrong parts, missing parts or excess parts.	Major	
	appearance	10. 4 Product packaging must the same as specified on packaging specification sheet.	Minor	
		10. 5 The folding and peeled off in polarizer are not acceptable.	Minor	
		10. 6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≤1.5 mm.	Minor	



4. Reliability Test

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION		
1	High Temperature Storage Test	Keep in 80 ±5°C 240 hrs		
2	Low Temperature Storage Test	Keep in -30 ±5°C 240 hrs		
3	High Temperature / High Humidity Storage Test	Keep in 60 °C / 90% R.H duration for 240 hrs (Excluding the polarizer)		
4	Temperature Cycling Storage Test	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$		
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- 1. Temperature ambiance: 15°C ~35°C 2. Humidity relative: 30% ~60% 3. Energy Storage Capacitance(Cs+Cd): 150pF±10% 4. Discharge Resistance(Rd): 330 Ω±10% 5. Discharge, mode of operation: Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication: ±5%)		
6	Vibration Test (Packaged)	 Sine wave 10~55 Hz frequency (1 min/sweep) The amplitude of vibration: 1. 5 mm Each direction (X, Y, Z) duration for 2 hrs 		
7	Drop Test (Packaged)	Packing Weight (Kg 0 ~ 45. 4 45. 4 ~ 90. 8 90. 8 ~ 454 Over 454 Drop Direction: %1 corner / 3 edg	122 76 61 46	

©Result Evaluation Criteria:

Under the display quality test conditions with normal operations with normal operation state. Do not change these conditions as such changes may affect practical display function.

(Normal operation state)
Temperature: +20~30°C
Humidity: 50~70%

Atmospheric pressure: 86~106Kpa



5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

- 5.1.1 If the LCD panel breaks, be careful not to get the liquid crystal to touch your skin.
- 5.1.2 If the liquid crystal touches your skin or clothes, please wash it off immediately by using soap and water.

5.2 HANDLING

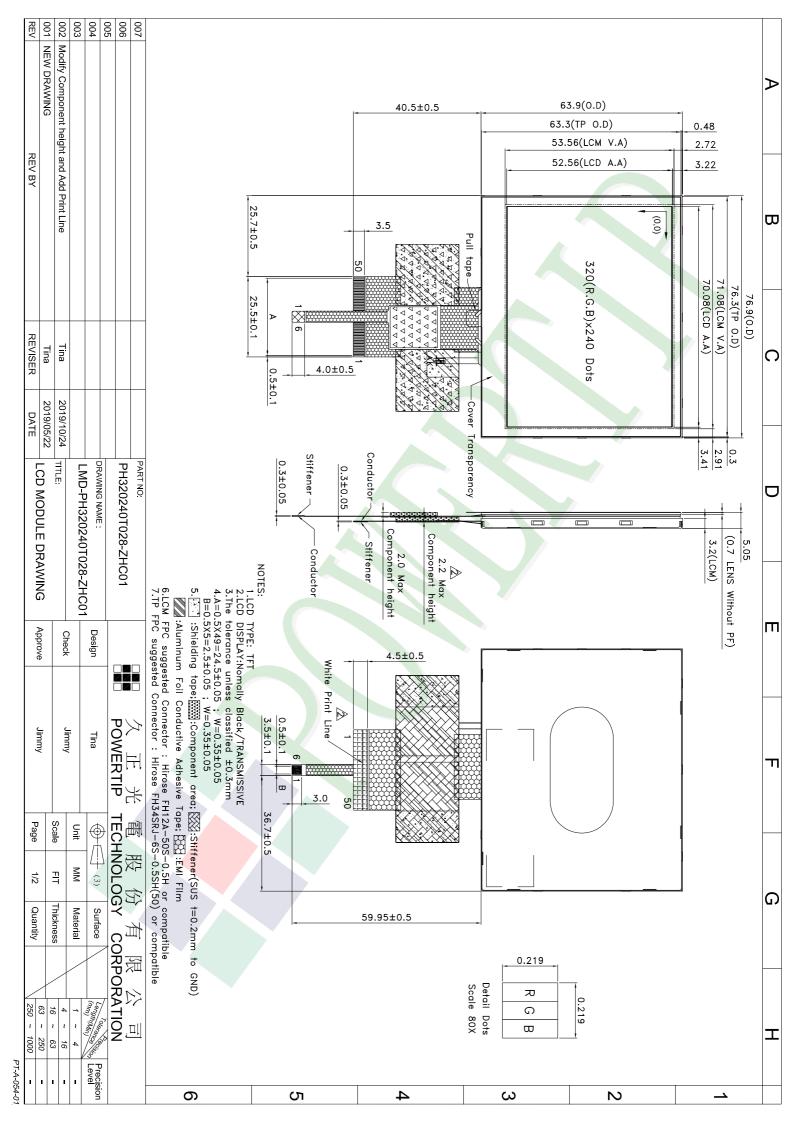
- 5.2.1 Avoid any strong mechanical shock which can break the glass.
- 5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module, be sure to ground your body and any electrical equipment you may be using.
- 5.2.3 Do not remove the panel or frame from the module.
- 5.2.4 The polarizing plate of the display is very fragile. So, please handle it very carefully, do not touch, push or rub the exposed polarizing with anything harder than an HB pencil lead (glass, tweezers, etc.)
- 5.2.5 Do not wipe the polarizing plate with a dry cloth, as it may easily scratch the surface of plate.
- 5.2.6 Do not touch the display area with bare hands, this will stain the display area.
- 5.2.7 Do not use ketonic solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.
- 5.2.8 To control temperature and time of soldering is $320 \pm 10^{\circ}$ C and $3 \sim 5$ sec.
- 5.2.9 To avoid liquid (include organic solvent) stained on LCM.
- 5.2.10 Caution! (LCM products with Capacitive Touch Panel)
 Strong EMI-sources such as switch-mode power supplies (SPS) can lead to touch malfunction (e.g., ghost-touches). Therefore, the touch needs to be thoroughly tested inside the target application.
- 5.2.11 CAUTION: Continuously displaying same static image will result in high possibility of image sticking/image burn-in effect due to TFT panel characteristic.
- 5.2.12 Double-sided tape designed to be attached with the customer's mechanical device, please follow up the rules and regulations published by the original manufacturer of double-side tape for the attachment operation.

5.3 STORAGE

- 5.3.1 Store the panel or module in a dark place where the temperature is 25°C ± 5°C and the humidity is below 65% RH.
- 5.3.2 Do not place the module near organics solvents or corrosive gases.
- 5.3.3 Do not crush, shake, or jolt the module.

5.4 TERMS OF WARRANTY

- 5.4.1 Applicable warrant period
 The period is within thirteen months since the date of shipping out under normal using and storage conditions.
- 5.4.2 Unaccepted responsibility
 - This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment, we cannot take responsibility if the product is used in nuclear power control equipment, aerospace equipment, fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



Approve Check Contact Ver.001 LCM包裝規格書 LCM Packaging Specifications Jimmy Clare Tina Documents NO. | PKG-PH320240T028-ZHC01 (For Tray) 1.包裝材料規格表 (Packaging Material): (per carton) No. Item Model Dimensions (mm) 1Pcs Weight Quantity Total Weight 1 PH320240T028-ZHC01 76.9X63.9X5.05 成品 (LCM) 252 0.046 11.592 多層薄膜(1)POF 2 19"X350X0.015 6 OTFILM0BA03ABA 3 TRAY 盤 (2)Tray TYSG000000137 352 X 260 X 12.3 0.1 48 4.8 内盒(3)Product Box 6 4 393 X 274 X 68 0.182 BX36627063ABBA 1.092 5 OTPLB00PL08ABA 550 X 393 X 20 0.0284 2 0.0568 保利龍板(4)Polylon board 6 外紙箱(5)Carton 570 X 410 X 265 BX57041027CCBA 1.0 1.0 7 8 9 2.一 整箱總重量 (Total LCD Weight in carton): 18.54 Kg±10% 3.單箱數量規格表 (Packaging Specifications and Quantity): (1)LCM quantity per box : no per tray 7 6 x no of tray 42 x no of boxes (2) Total LCM quantity in carton: quantity per box 42 6 252 Use empty tray 空盤 (4)保利龍板 (1)多層薄膜 Polylon board **POF** Put products into the tray (2)TRAY 盤 Tray (5)外紙箱 Carton Tray stacking (3)内盒 Product Box 特 記 事 項 (REMARK) 斜角 Detail B Tray 2 TRAY盤相疊時,需旋轉180度,請詳見B視圖 Rotate tray 180 degrees and place on top of stack. Check the tray stack using Fig. B.